Sensors and Materials
Special Issue on Sensor Technology
Call for Papers

Sensors are used in everyday life to measure strength, distance, height, and pressure, and so forth. They are also widely used in intelligent manufacturing and IoT. This special issue focuses on sensors used in everyday life, manufacturing, and IoT applications, including materials, systems, design, and manufacturing techniques. Such materials include carbon, metals, ceramics, polymers, and related composite materials. In addition, papers on sensor applications of biomolecular materials, microorganisms, and various organic and inorganic materials are all welcomed.

Scope:
Sensor design Sensor applications
Sensor materials Sensor fabrication

Submission due date: October 31, 2022 extended to March 31, 2023
Publication date (planned): Former half of 2023
Journal website: https://sensors.myu-group.co.jp/
Guest Editor: Shih-Chen Shi (National Cheng Kung University) and Tao-Hsing Chen (National Kaohsiung University of Science and Technology)
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If you have any questions, please feel free to contact the editorial staff at the address below.

Editorial Department of Sensors and Materials
MYU K.K.
1-23-3-303 Sendagi, Bunkyo-ku, Tokyo 113-0022, Japan
Tel: +81-3-3827-8549, Fax: +81-3-3827-8547
E-mail: myukk@myu-inc.jp